Silicon Epitaxial Planar Diode for High Speed Switching

HITACHI

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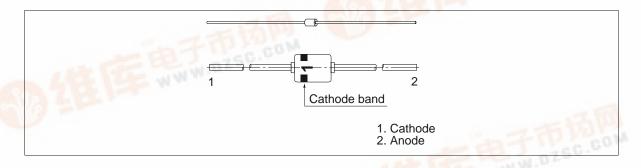
Features

- Low capacitance. (C = 3.0pF max)
- Short reverse recovery time. $(t_{rr} = 3.5 \text{ns max})$
- Small glass package (MHD) enables easy mounting and high reliability.

Ordering Information

Type No.	Cathode band	Mark	Package Code	
1SS120	Light Blue	1	MHD	-

Outline





Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

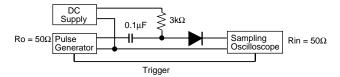
Item	Symbol	Value	Unit	
Peak reverse voltage	V_{RM}	70	V	
Reverse voltage	V _R	60	V	
Peak forward current	I _{FM}	450	mA	
Non-Repetitive peak forward surge current	I _{FSM} *	1	А	
Average forward current	Io	150	mA	
Power dissipation	Pd	250	mW	
Junction temperature	Tj	175	°C	
Storage temperature	Tstg	-65 to +175	°C	

Note: Within 1s forward surge current.

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Forward voltage	V_{F}	_	_	0.8	V	I _F = 10mA
Reverse current	I _R	_	_	0.1	μΑ	V _R = 60V
Capacitance	С	_	_	3.0	pF	$V_R = 1V$, $f = 1MHz$
Reverse recovery time	t _{rr} *	_	_	3.5	ns	$I_F = 10$ mA, $V_R = 6$ V, $R_L = 50\Omega$

Note: Reverse recovery time test circuit



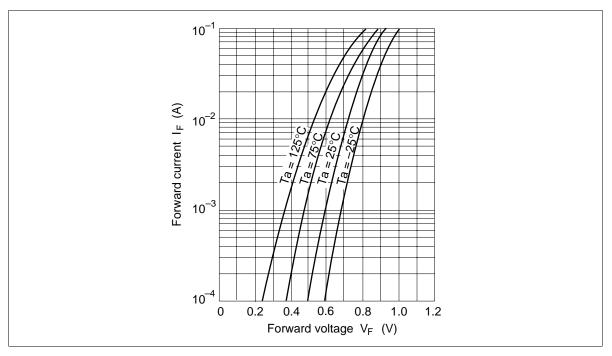


Fig.1 Forward current Vs. Forward voltage

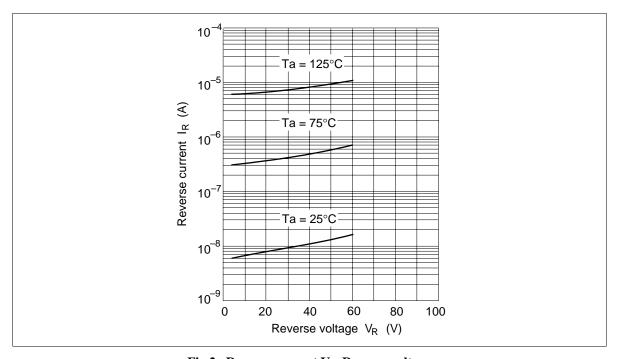


Fig.2 Reverse current Vs. Reverse voltage

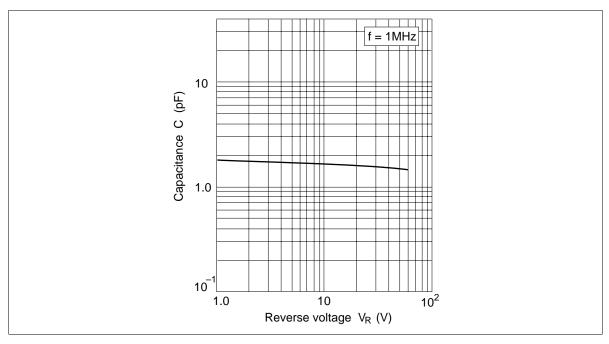
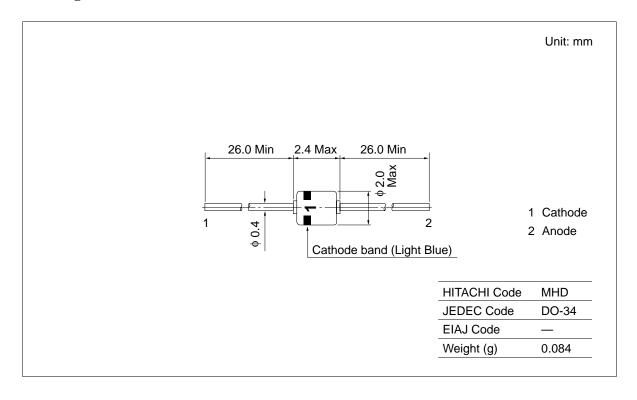


Fig.3 Capacitance Vs. Reverse voltage

Package Dimensions



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